



## Surface Mount Glass Passivated Ultrafast Rectifier

**SUPERRECTIFIER®**



**DO-213AB (GL41)**

Patented\*

\*Glass-plastic encapsulation is covered by Patent No. 3,996,602, brazed-lead assembly to Patent No. 3,930,306

### FEATURES

- Cavity-free glass-passivated junction
- Ideal for automated placement
- Ultrafast reverse recovery time
- Low switching losses, high efficiency
- High forward surge capability
- Meets environmental standard MIL-S-19500
- Meets MSL level 1, per J-STD-020C, LF max peak of 250 °C
- Solder Dip 260 °C, 40 seconds
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



### TYPICAL APPLICATIONS

For use in high frequency rectification and free-wheeling application in switching mode converters and inverters for consumer, computer, automotive and telecommunication.

### MECHANICAL DATA

**Case:** DO-213AB, molded epoxy over glass body

Epoxy meets UL 94V-0 flammability rating

**Terminals:** Matte tin plated leads, solderable per J-STD-002B and JESD22-B102D

E3 suffix for commercial grade, HE3 suffix for high reliability grade (AEC Q101 qualified)

**Polarity:** Two bands indicate cathode end - 1st band denotes device type and 2nd band denotes repetitive peak reverse voltage rating

MAJOR RATINGS AND CHARACTERISTICS	
$I_{F(AV)}$	1.0 A
$V_{RRM}$	50 V to 400 V
$I_{FSM}$	30 A
$t_{rr}$	50 ns
$V_F$	1.0 V, 1.25 V
$T_j \text{ max.}$	175 °C

MAXIMUM RATINGS ( $T_A = 25 \text{ °C}$ unless otherwise noted)								
PARAMETER	SYMBOL	BYM12-50	BYM12-100	BYM12-150	BYM12-200	BYM12-300	BYM12-400	UNIT
Fast efficient device: 1st band is Green		EGL41A	EGL41B	EGL41C	EGL41D	EGL41F	EGL41G	
Polarity color bands (2nd Band)		Gray	Red	Pink	Orange	Brown	Yellow	
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	150	200	300	400	V
Maximum RMS voltage	$V_{RMS}$	35	70	105	140	210	280	V
Maximum DC blocking voltage	$V_{DC}$	50	100	150	200	300	400	V
Maximum average forward rectified current at $T_T = 75 \text{ °C}$	$I_{F(AV)}$	1.0						A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	$I_{FSM}$	30						A
Operating junction and storage temperature range	$T_J, T_{STG}$	- 65 to + 175						°C



<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)									
PARAMETER	TEST CONDITIONS	SYMBOL	BYM12-50	BYM12-100	BYM12-150	BYM12-200	BYM12-300	BYM12-400	UNIT
			EGL41A	EGL41B	EGL41C	EGL41D	EGL41F	EGL41G	
Maximum instantaneous forward voltage <sup>(1)</sup>	at 1.0 A	$V_F$	1.0				1.25		V
Maximum DC reverse current at rated DC blocking voltage <sup>(1)</sup>	$T_A = 25\text{ }^\circ\text{C}$ $T_A = 125\text{ }^\circ\text{C}$	$I_R$				5.0 50			$\mu\text{A}$
Max. reverse recovery time	at $I_F = 0.5\text{ A}$ , $I_R = 1.0\text{ A}$ , $I_{rr} = 0.25\text{ A}$	$t_{rr}$				50			ns
Typical junction capacitance	at 4.0 V, 1 MHz	$C_J$	20				14		pF

**Note:**

(1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)									
PARAMETER	SYMBOL	BYM12-50	BYM12-100	BYM12-150	BYM12-200	BYM12-300	BYM12-400	UNIT	
		EGL41A	EGL41B	EGL41C	EGL41D	EGL41F	EGL41G		
Maximum thermal resistance <sup>(1,2)</sup>	$R_{\theta JA}$				60				$^\circ\text{C/W}$
	$R_{\theta JT}$				30				

**Note:**

(1) Thermal resistance from junction to ambient, 0.24 x 0.24" (6.0 x 6.0 mm) copper pads to each terminal

(2) Thermal resistance from junction to terminal, 0.24 x 0.24" (6.0 x 6.0 mm) copper pads to each terminal

<b>ORDERING INFORMATION</b>				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
EGL41D-E3/96	0.114	96	1500	7" Diameter Plastic Tape & Reel
EGL41D-E3/97	0.114	97	5000	13" Diameter Plastic Tape & Reel



**RATINGS AND CHARACTERISTICS CURVES**

( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)

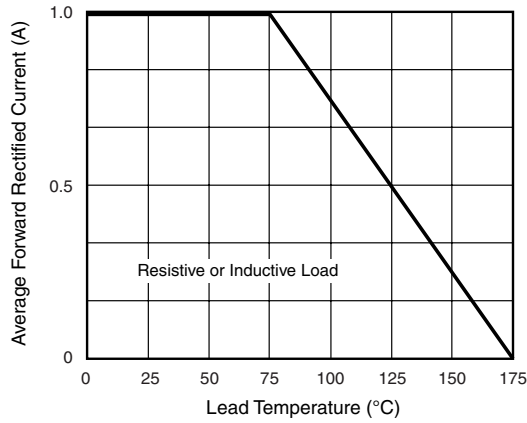


Figure 1. Maximum Forward Current Derating Curve

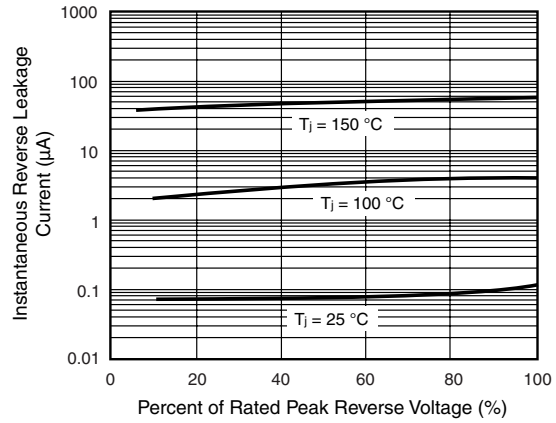


Figure 4. Typical Reverse Leakage Characteristics

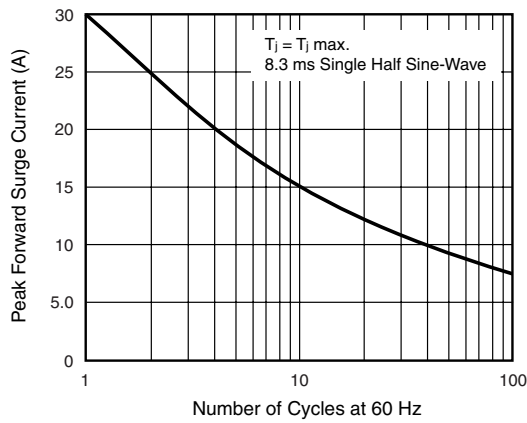


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

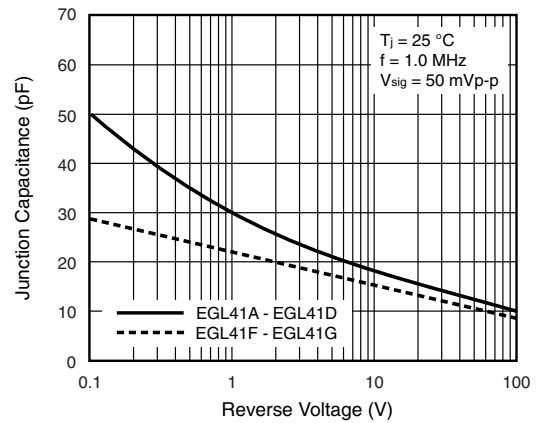


Figure 5. Typical Junction Capacitance

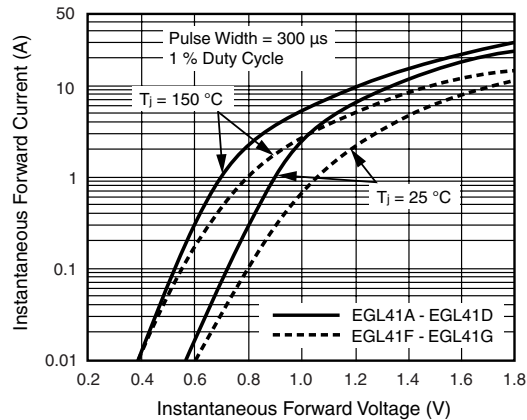


Figure 3. Typical Instantaneous Forward Characteristics

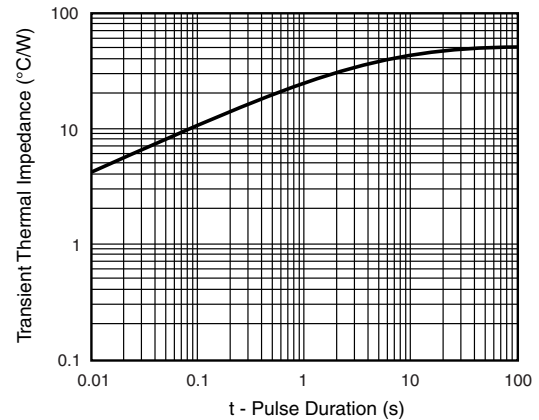
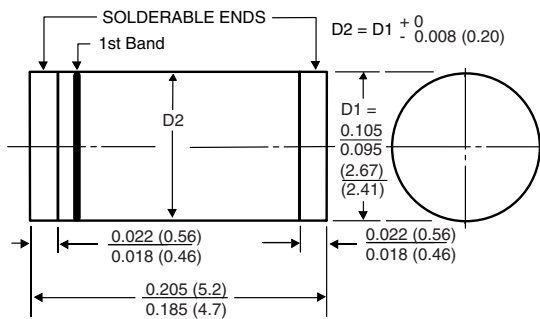


Figure 6. Typical Transient Thermal Impedance

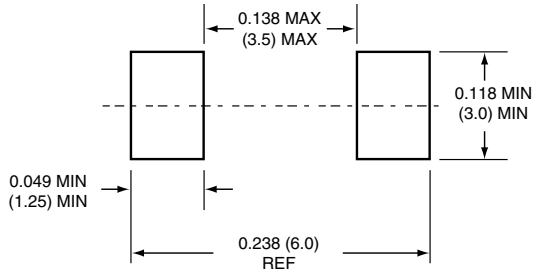
## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

### DO-213AB (GL41)



1st band denotes type and positive end (cathode)

### Mounting Pad Layout





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